Features

Estes metais tratados Terno auxiliar de soldagem dupla face É duplicado e fornece 12 programas, incluindo 2 pincéis de limpeza de solda fechar hastes de soldagem.

Você terá muito uso disso P.C.Terno auxiliar de solda de placas !Geral 185 mm de comprimento de 75 mm.Apenas mantenha isso Terno auxiliar de soldagem Para uso futuro.

Specification

SA-10 6 Auxílios de soldagem de alta qualidade

1. Pincel: limpeza antes da soldagem
2. Raspador: descarregando o fluxo residual e restante solda
3. Faca: usado para cortar a pista PCB
4. Gancho: Para ingredientes e mineração de chumbo
5. Garfo: fio adequado até 22swg.Para embalagens e expansão, etc.
6. Spike: para liquidação e tag

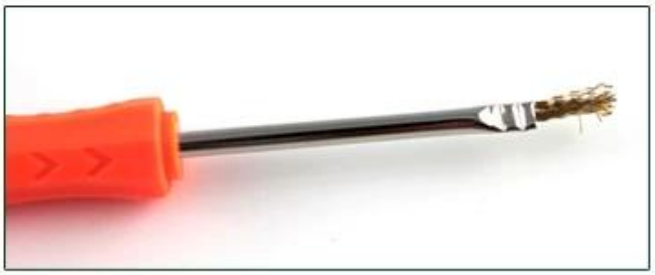
产品描述

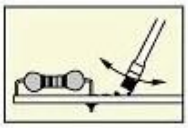
名称：	6件套助焊工具	型号：	BST-SA-10
品牌：	倍思特	磁性：	不带磁性
尺寸：	185mm	重量：	85g
特点1：	针对机板修补、组立、拆除元件、研磨、清洁，除锡而设计		
特点2：	将焊接维修时所常用的压、钻、撬、戳、切、刮、钩、拉、顶、刷...等12种需求集中在6支辅助工具上		
特点3：	用于安装和维修电路板，广泛应用于印刷电路板（PCB）的焊接组装和维修工作		

产品尺寸

产品说明

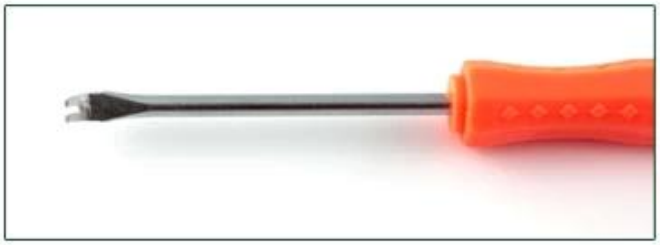
BST-SA-10：刷子

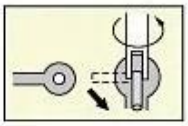




焊锡前清除焊锡部位的粉尘和残留物
清除焊锡时产生的锡球，去除锈斑

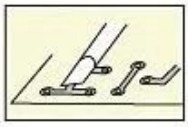
BST-SA-10：叉



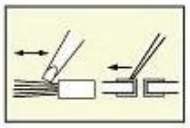


固定或调整元件的引脚和连接线
及电阻、电容等元件脚成型用

BST-SA-10：刀

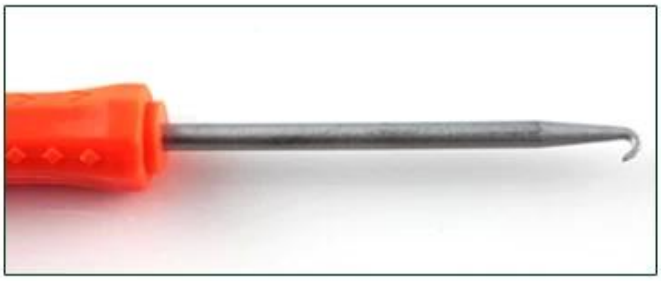


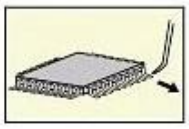
可切割印刷线路板上的敷铜连接线，印刷电路回路修正，切断，去绣时使用



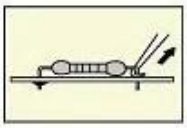
去残留的焊锡和助焊剂清除焊盘和金手指上的化层，刮锈蚀，氧化层等用

BST-SA-10：勾



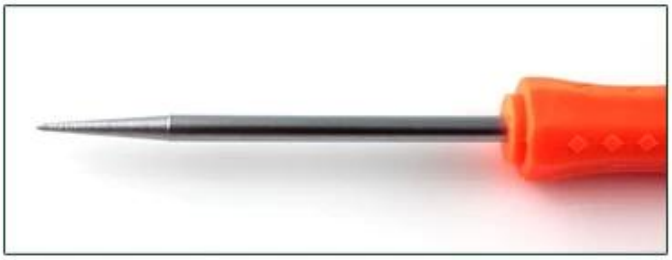


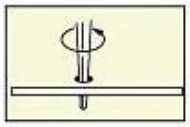
平面集成电路元件，拆取时使用，电烙铁边溶解边拆除



拆除电阻元件时使用，电烙铁边溶解边拆除

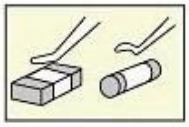
BST-SA-10：铰刀





印刷电路板孔扩大及焊锡堵塞孔的修复用

BST-SA-10：压头



小型电子元件压紧，定位后锡焊
圆形元件，平时元件对应压头